

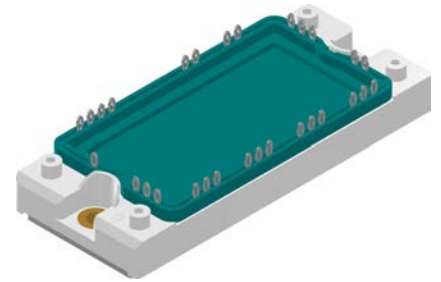
# Standard Rectifier Module

| 3~ Rectifier               | Brake Chopper                 |
|----------------------------|-------------------------------|
| $V_{RRM} = 1600 \text{ V}$ | $V_{CES} = 1200 \text{ V}$    |
| $I_{DAV} = 360 \text{ A}$  | $I_{C25} = 250 \text{ A}$     |
| $I_{FSM} = 1900 \text{ A}$ | $V_{CE(sat)} = 1,7 \text{ V}$ |


## 3~ Rectifier Bridge + Brake Unit + NTC

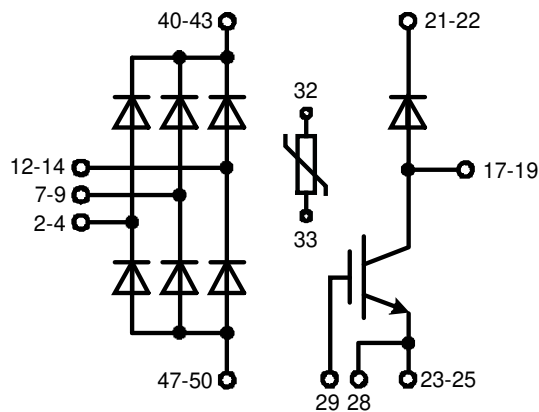
Part number

**MDMA360UB1600PTED**



Backside: isolated

 E72873



### Features / Advantages:

- Package with DCB ceramic
- Improved temperature and power cycling
- Planar passivated chips
- Very low forward voltage drop
- Very low leakage current
- NTC

### Applications:

- 3~ Rectifier with brake unit for drive inverters

### Package: E2-Pack

- Isolation Voltage: 4300 V~
- Industry standard outline
- RoHS compliant
- PressFit-Pins for PCB mounting
- Height: 17 mm
- Base plate: Copper internally DCB isolated
- Advanced power cycling
- Phase Change Material available

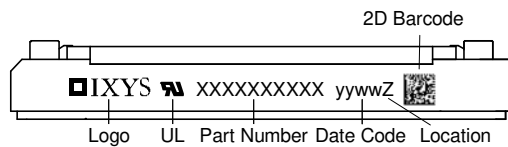
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| Rectifier  |  |                                   |                   | Ratings                      |      |      |                   |
|------------|--|-----------------------------------|-------------------|------------------------------|------|------|-------------------|
| Symbol     | Definition                                   | Conditions                        |                   | min.                         | typ. | max. | Unit              |
| $V_{RSM}$  | max. non-repetitive reverse blocking voltage |                                   |                   |                              |      | 1700 | V                 |
| $V_{RRM}$  | max. repetitive reverse blocking voltage     |                                   |                   |                              |      | 1600 | V                 |
| $I_R$      | reverse current                              | $V_R = 1600$ V                    |                   | $T_{VJ} = 25^\circ\text{C}$  |      | 100  | $\mu\text{A}$     |
|            |  | $V_R = 1600$ V                    |                   | $T_{VJ} = 150^\circ\text{C}$ |      | 3    | mA                |
| $V_F$      | forward voltage drop                         | $I_F = 120$ A                     |                   | $T_{VJ} = 25^\circ\text{C}$  |      | 1,25 | V                 |
|            |  | $I_F = 360$ A                     |                   |                              |      | 1,80 | V                 |
|            |  | $I_F = 120$ A                     |                   | $T_{VJ} = 125^\circ\text{C}$ |      | 1,23 | V                 |
|            |  | $I_F = 360$ A                     |                   |                              |      | 1,98 | V                 |
| $I_{DAV}$  | bridge output current                        | $T_C = 85^\circ\text{C}$          |                   | $T_{VJ} = 150^\circ\text{C}$ |      | 360  | A                 |
|            |  | rectangular                       | $d = \frac{1}{3}$ |                              |      |      |                   |
| $V_{FO}$   | threshold voltage                            | } for power loss calculation only |                   |                              |      | 0,82 | V                 |
| $r_F$      | slope resistance                             |                                   |                   |                              |      | 3,4  | m $\Omega$        |
| $R_{thJC}$ | thermal resistance junction to case          |                                   |                   |                              |      | 0,25 | K/W               |
| $R_{thCH}$ | thermal resistance case to heatsink          |                                   |                   |                              |      | 0,1  | K/W               |
| $P_{tot}$  | total power dissipation                      |                                   |                   | $T_C = 25^\circ\text{C}$     |      | 500  | W                 |
| $I_{FSM}$  | max. forward surge current                   | $t = 10$ ms; (50 Hz), sine        |                   | $T_{VJ} = 45^\circ\text{C}$  |      | 1,90 | kA                |
|            |  | $t = 8,3$ ms; (60 Hz), sine       |                   | $V_R = 0$ V                  |      | 2,05 | kA                |
|            |  | $t = 10$ ms; (50 Hz), sine        |                   | $T_{VJ} = 150^\circ\text{C}$ |      | 1,62 | kA                |
|            |  | $t = 8,3$ ms; (60 Hz), sine       |                   | $V_R = 0$ V                  |      | 1,75 | kA                |
| $I^2t$     | value for fusing                             | $t = 10$ ms; (50 Hz), sine        |                   | $T_{VJ} = 45^\circ\text{C}$  |      | 18,1 | kA <sup>2</sup> s |
|            |  | $t = 8,3$ ms; (60 Hz), sine       |                   | $V_R = 0$ V                  |      | 17,5 | kA <sup>2</sup> s |
|            |  | $t = 10$ ms; (50 Hz), sine        |                   | $T_{VJ} = 150^\circ\text{C}$ |      | 13,0 | kA <sup>2</sup> s |
|            |  | $t = 8,3$ ms; (60 Hz), sine       |                   | $V_R = 0$ V                  |      | 12,7 | kA <sup>2</sup> s |
| $C_J$      | junction capacitance                         | $V_R = 400$ V; $f = 1$ MHz        |                   | $T_{VJ} = 25^\circ\text{C}$  |      | 73   | pF                |

| Brake IGBT + Diode |                                      |  |                         | Ratings |          |         |  |
|--------------------|--------------------------------------|--|-------------------------|---------|----------|---------|--|
| Symbol             | Definition                           | Conditions   | min.                    | typ.    | max.     | Unit    |  |
| $V_{CES}$          | collector emitter voltage            | $T_{VJ} = 25^{\circ}C$   |                         |         | 1200     | V       |  |
| $V_{GES}$          | max. DC gate voltage                 |  |                         |         | $\pm 20$ | V       |  |
| $V_{GEM}$          | max. transient gate emitter voltage  |  |                         |         | $\pm 30$ | V       |  |
| $I_{C25}$          | collector current                    | $T_C = 25^{\circ}C$  |                         |         | 250      | A       |  |
| $I_{C80}$          |                                      | $T_C = 80^{\circ}C$  |                         |         | 175      | A       |  |
| $P_{tot}$          | total power dissipation              | $T_C = 25^{\circ}C$  |                         |         | 780      | W       |  |
| $V_{CE(sat)}$      | collector emitter saturation voltage | $I_C = 150\text{ A}; V_{GE} = 15\text{ V}$   |                         |         | 1,7      | V       |  |
|                    |                                      |  |                         |         | 1,9      | V       |  |
| $V_{GE(th)}$       | gate emitter threshold voltage       | $I_C = 6\text{ mA}; V_{GE} = V_{CE}$   | 6                       | 6,8     | 7,5      | V       |  |
| $I_{CES}$          | collector emitter leakage current    | $V_{CE} = V_{CES}; V_{GE} = 0\text{ V}$  |                         |         | 0,1      | mA      |  |
|                    |                                      |  |                         | 1       |          | mA      |  |
| $I_{GES}$          | gate emitter leakage current         | $V_{GE} = \pm 20\text{ V}$   |                         |         | 500      | nA      |  |
| $Q_{G(on)}$        | total gate charge                    | $V_{CE} = 600\text{ V}; V_{GE} = 15\text{ V}; I_C = 150\text{ A}$  |                         | 510     |          | nC      |  |
| $t_{d(on)}$        | turn-on delay time                   | inductive load<br>$V_{CE} = 600\text{ V}; I_C = 150\text{ A}$<br>$V_{GE} = \pm 15\text{ V}; R_G = 4,7\ \Omega$ | $T_{VJ} = 125^{\circ}C$ |         | 280      | ns      |  |
| $t_r$              | current rise time                    |  |                         |         | 80       | ns      |  |
| $t_{d(off)}$       | turn-off delay time                  |  |                         |         | 440      | ns      |  |
| $t_f$              | current fall time                    |  |                         |         | 230      | ns      |  |
| $E_{on}$           | turn-on energy per pulse             |  |                         |         | 26       | mJ      |  |
| $E_{off}$          | turn-off energy per pulse            |  |                         |         | 15       | mJ      |  |
| <b>RBSOA</b>       | reverse bias safe operating area     | $V_{GE} = \pm 15\text{ V}; R_G = 4,7\ \Omega$  |                         |         |          |         |  |
| $I_{CM}$           |                                      | $V_{CEK} = 1200\text{ V}$  |                         |         | 400      | A       |  |
| <b>SCSOA</b>       | short circuit safe operating area    | $V_{CEK} = 1200\text{ V}$  |                         |         |          |         |  |
| $t_{SC}$           | short circuit duration               | $V_{CE} = 900\text{ V}; V_{GE} = \pm 15$   |                         |         | 10       | $\mu s$ |  |
| $I_{SC}$           | short circuit current                | $R_G = 4,7\ \Omega$ ; non-repetitive   |                         | 600     |          | A       |  |
| $R_{thJC}$         | thermal resistance junction to case  |  |                         |         | 0,16     | K/W     |  |
| $R_{thCH}$         | thermal resistance case to heatsink  |  |                         |         | 0,10     | K/W     |  |
| <b>Brake Diode</b> |                                      |  |                         |         |          |         |  |
| $V_{RRM}$          | max. repetitive reverse voltage      | $T_{VJ} = 25^{\circ}C$   |                         |         | 1200     | V       |  |
| $I_{F25}$          | forward current                      | $T_C = 25^{\circ}C$  |                         |         | 135      | A       |  |
| $I_{F80}$          |                                      | $T_C = 80^{\circ}C$  |                         |         | 90       | A       |  |
| $V_F$              | forward voltage                      | $I_F = 100\text{ A}$   |                         |         | 2,20     | V       |  |
|                    |                                      |  |                         |         | 1,95     | V       |  |
| $I_R$              | reverse current                      | $V_R = V_{RRM}$  |                         |         | 0,1      | mA      |  |
|                    |                                      |  |                         |         | 1,2      | mA      |  |
| $Q_{rr}$           | reverse recovery charge              | $V_R = 600\text{ V}$<br>$-di_F/dt = 1600\text{ A}/\mu s$<br>$I_F = 100\text{ A}; V_{GE} = 0\text{ V}$          | $T_{VJ} = 125^{\circ}C$ |         | 12,5     | $\mu C$ |  |
| $I_{RM}$           | max. reverse recovery current        |  |                         |         | 100      | A       |  |
| $t_{rr}$           | reverse recovery time                |  |                         |         | 350      | ns      |  |
| $E_{rec}$          | reverse recovery energy              |  |                         |         | 4        | mJ      |  |
| $R_{thJC}$         | thermal resistance junction to case  |  |                         |         | 0,4      | K/W     |  |
| $R_{thCH}$         | thermal resistance case to heatsink  |  |                         |         | 0,1      | K/W     |  |

| Package E2-Pack |  | Ratings                             |      |      |      |      |
|-----------------|--|-------------------------------------|------|------|------|------|
| Symbol          | Definition   | Conditions                          | min. | typ. | max. | Unit |
| $I_{RMS}$       | RMS current  | per terminal                        |      |      | 30   | A    |
| $T_{VJ}$        | virtual junction temperature                                 |                                     | -40  |      | 150  | °C   |
| $T_{op}$        | operation temperature  |                                     | -40  |      | 125  | °C   |
| $T_{stg}$       | storage temperature  |                                     | -40  |      | 125  | °C   |
| <b>Weight</b>   |  |                                     |      | 176  |      | g    |
| $M_D$           | mounting torque  |                                     | 3    |      | 6    | Nm   |
| $d_{Spp/APP}$   | creepage distance on surface   striking distance through air | terminal to terminal                | 6,0  |      |      | mm   |
| $d_{Spb/APb}$   |  | terminal to backside                | 12,0 |      |      | mm   |
| $V_{ISOL}$      | isolation voltage  | t = 1 second<br>t = 1 minute        | 4300 |      |      | V    |
|                 |  | 50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA | 3600 |      |      | V    |



### Part description

M = Module  
 D = Diode  
 M = Standard Rectifier  
 A = (up to 1800V)  
 360 = Current Rating [A]  
 UB = 3- Rectifier Bridge + Brake Unit  
 1600 = Reverse Voltage [V]  
 PT = PressFit-Pin, Thermistor  
 ED = E2-Pack  
 - = Hyphen  
 PC = Phase Change Material

| Ordering    | Ordering Number      | Marking on Product | Delivery Mode | Quantity | Code No. |
|-------------|----------------------|--------------------|---------------|----------|----------|
| Standard    | MDMA360UB1600PTED    | MDMA360UB1600PTED  | Blister       | 28       | 516620   |
| Alternative | MDMA360UB1600PTED-PC | MDMA360UB1600PTED  | Blister       | 28       | 515423   |

### Temperature Sensor NTC

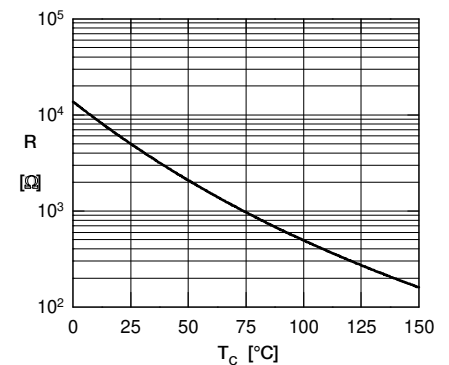
| Symbol      | Definition              | Conditions          | min. | typ. | max. | Unit       |
|-------------|-------------------------|---------------------|------|------|------|------------|
| $R_{25}$    | resistance              | $T_{VJ} = 25^\circ$ | 4,85 | 5    | 5,15 | k $\Omega$ |
| $B_{25/50}$ | temperature coefficient |                     |      | 3375 |      | K          |

### Equivalent Circuits for Simulation

\* on die level

$T_{VJ} = 150^\circ\text{C}$

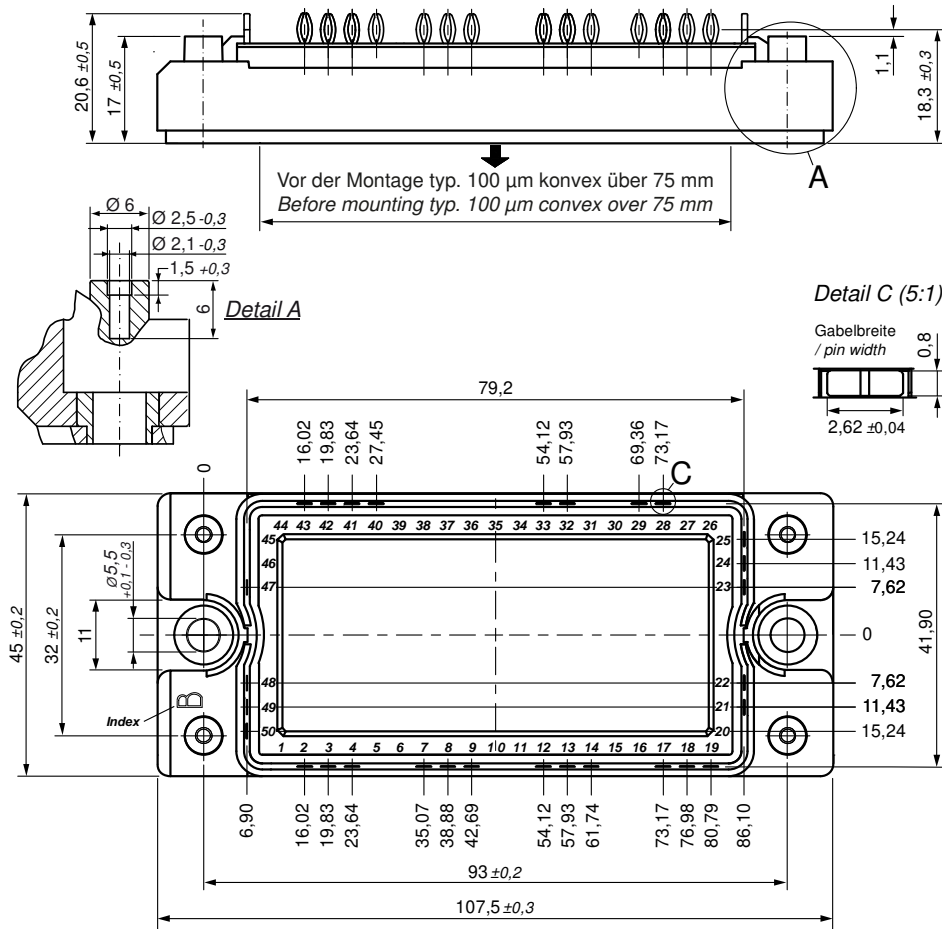
|       | Rectifier | Brake IGBT + | Brake Diode |            |
|-------|-----------|--------------|-------------|------------|
| $V_0$ | 0,82      | 1,1          | 1,25        | V          |
| $R_0$ | 1,5       | 9,2          | 8,5         | m $\Omega$ |



Typ. NTC resistance vs. temperature



**Outlines E2-Pack**

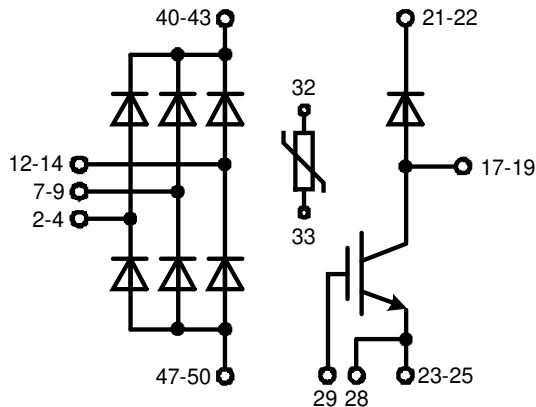


**Bemerkung / Note:**

- Nicht tolerierte Maße nach / Measure without tolerances according DIN ISO 2768-T1-m
- PCB-Lochmuster / PCB hole pattern: **see pin position**
- Toleranz Pin-Position und PCB-Lochmuster / Tolerance of pin position and PCB hole pattern:  $\oplus 0,1$
- Bohrlochdurchmesser / Diameter of drill: **Ø 2.35 mm**
- Endlochdurchmesser / Diameter of plated holes: **Ø 2.14 - 2.29 mm** (Cu thickness in via typ. 50 µm)
- Beschichtung / Plating: **chem. Sn max. 15 µm**
- Einpresskraft / Insert Force: per terminal with a typ. insert speed of 7 mm/s: **typ. 90 N**
- Weitere Angaben / Further information: [www.ixys.com](http://www.ixys.com) **Application note IXAN0077**
- Montageanleitung / Mounting instruction: [www.ixys.com](http://www.ixys.com) **Application note IXAN0024**

**Detail A:** PCB-Montage / Mounting on PCB-

- Empfohlene, selbstschneidende Schraube / Recommended, self-tapping screw: **EJOT PT®** (Größe / size: **K25**)
- Max. Schraubenlänge / Max. screw length: **PCB-Dicke / thickness + 6 mm** (max. Lochtiefe / hole depth)
- Empfohlenes Drehmoment / Recommended mounting torque: **1.5 Nm**



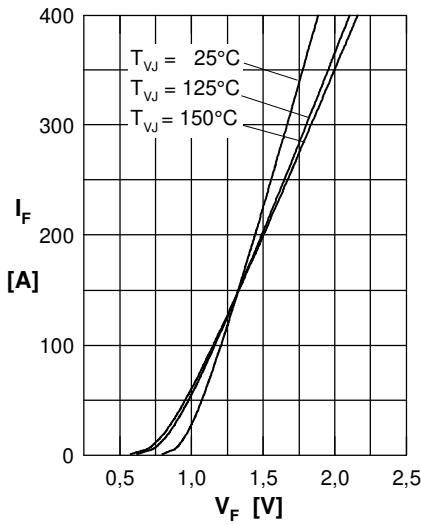
**Rectifier**


Fig. 1 Forward current versus voltage drop per diode

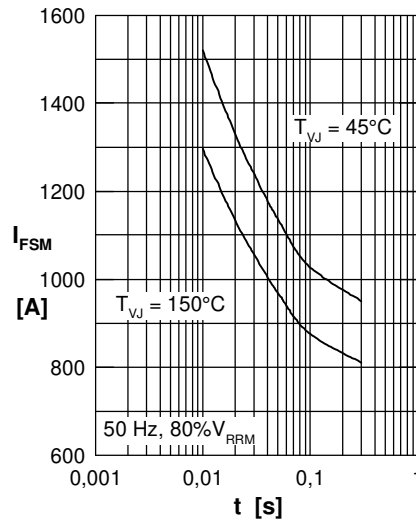


Fig. 2 Surge overload current vs. time per diode

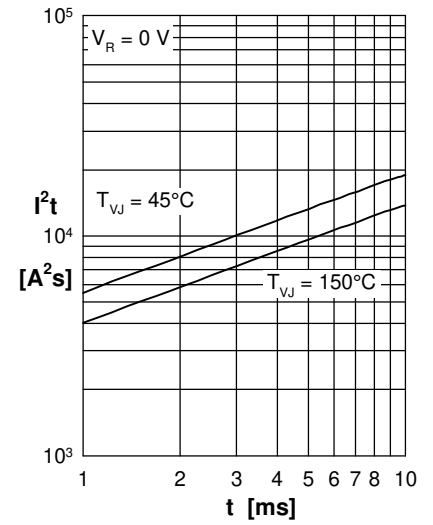
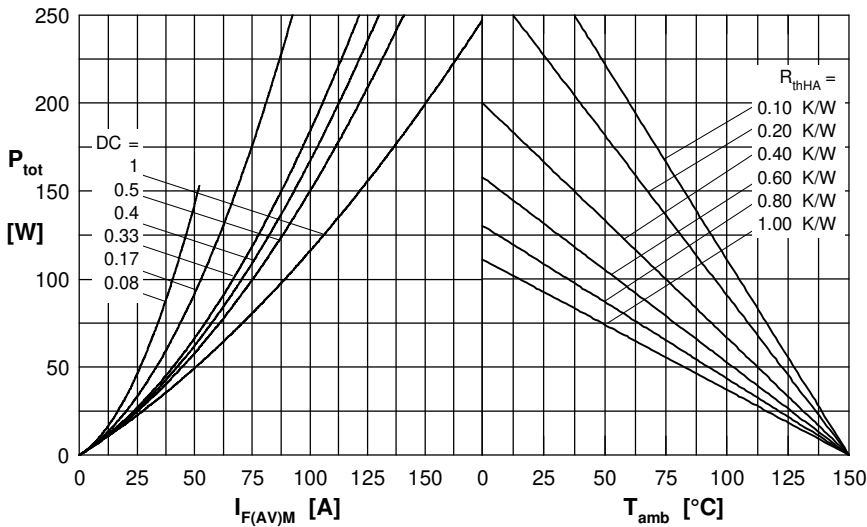

 Fig. 3  $I^2t$  versus time per diode


Fig. 4 Power dissipation vs. forward current and ambient temperature per diode

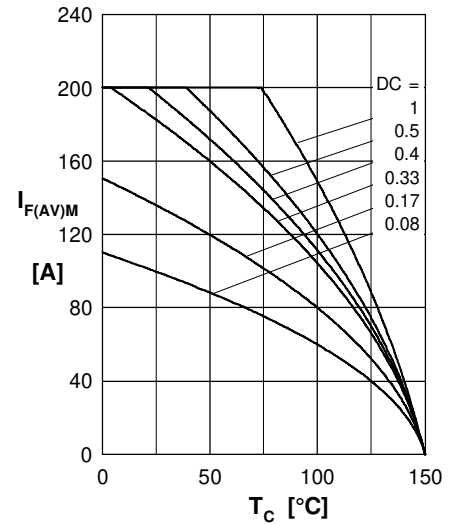


Fig. 5 Max. forward current vs. case temperature per diode

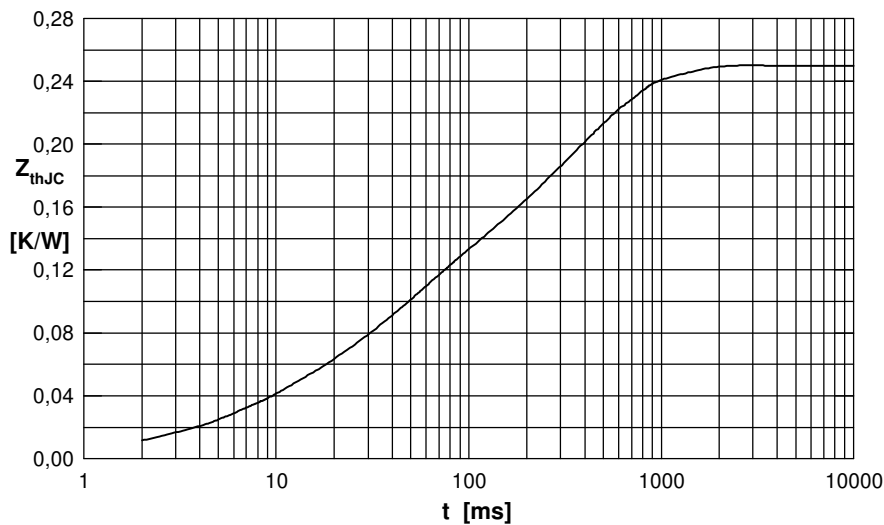


Fig. 6 Transient thermal impedance junction to case vs. time per diode

 Constants for  $Z_{thJC}$  calculation:

| i | $R_{thi}$ (K/W) | $t_i$ (s) |
|---|-----------------|-----------|
| 1 | 0.020           | 0.006     |
| 2 | 0.003           | 0.007     |
| 3 | 0.080           | 0.037     |
| 4 | 0.147           | 0.360     |

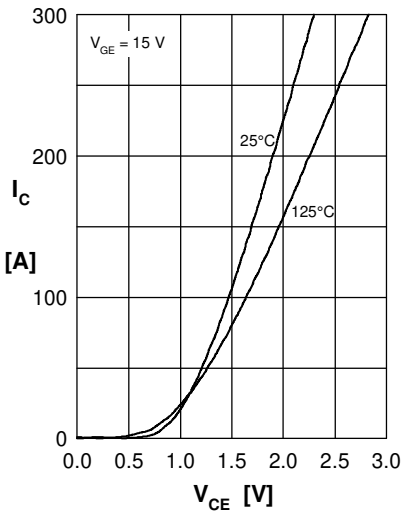
**Brake IGBT + Diode**


Fig.1 Output characteristics IGBT

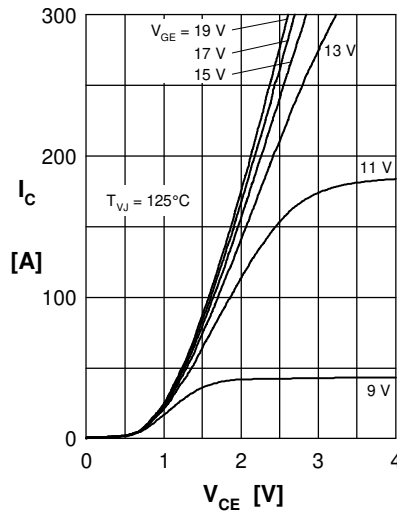


Fig.2 Typ. output characteristics IGBT

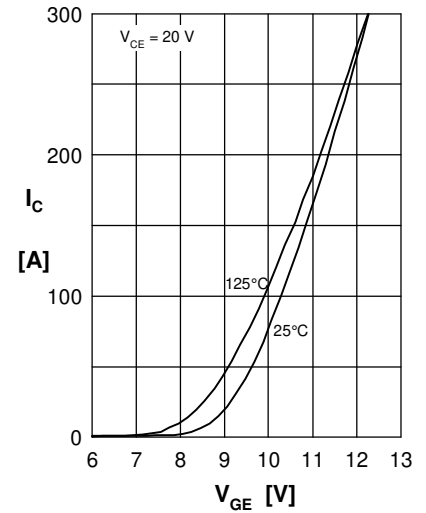


Fig.3 Typ. transfer charact. IGBT

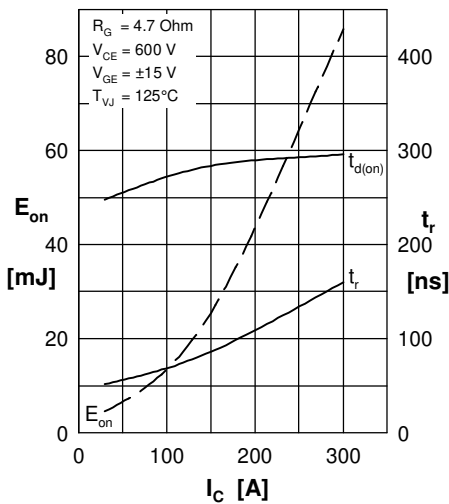


Fig.4 Typ. turn-on energy &amp; switch. times vs. collector current

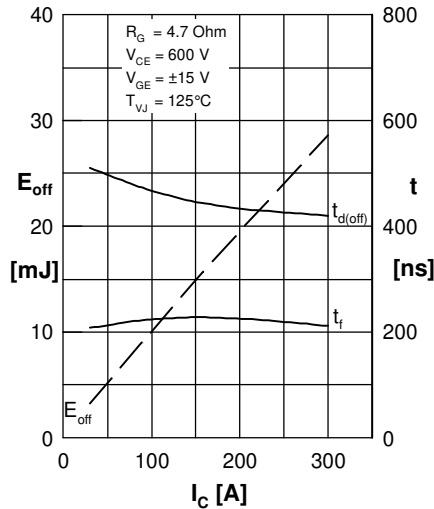


Fig.5 Typ. turn-off energy &amp; switch. times vs. collector current

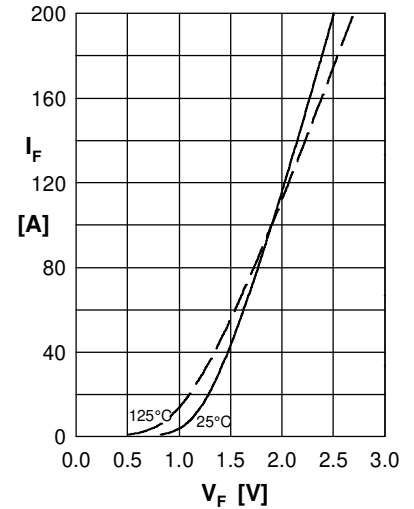


Fig.6 Typ. forward characteristics Diode

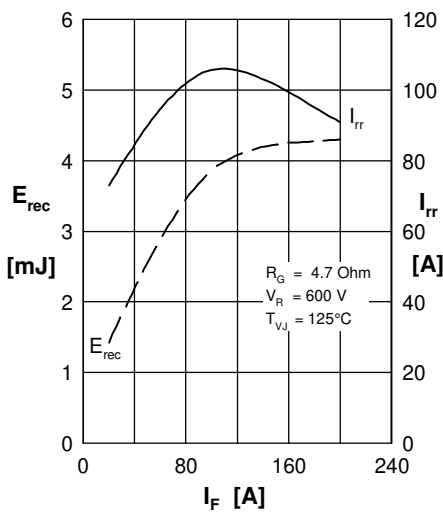


Fig.7 Typ. reverse recovery characteristics Diode

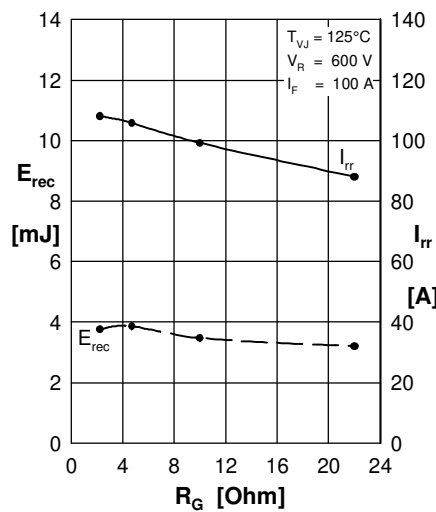


Fig.8 Typ. reverse recovery characteristics Diode

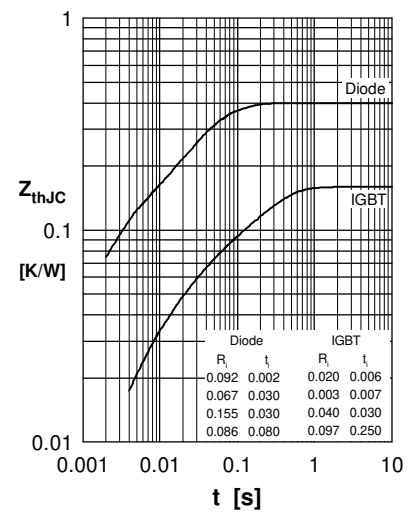


Fig.9 Transient thermal resistance junction to case